

Inventor Information

Inventor One Given Name:: Ikuya
Family Name:: MIYAZAWA
Name Suffix::
City of Residence:: Suwa-shi
State or Prov. of Residence::
Country of Residence:: Japan
Citizenship Country:: Japan

Correspondence Information

Correspondence Customer Number:: 25944

Application Information

Title Line One:: SOLDERING METHOD, SOLDERING DEVICE,
Title Line Two:: AND METHOD AND DEVICE OF FABRICATING
Title Line Three:: ELECTRONIC CIRCUIT MODULE
Total Drawing Sheets:: 5
Docket Number:: 112155

Prior Foreign Applications

Foreign Application One:: 2001-75534
Filing Date:: March 16, 2001
Country:: Japan
Priority Claimed:: yes

Assignee Information

Name of assignee:: SEIKO EPSON CORPORATION
Assignee Address Line One:: 4-1, Nishi-shinjuku 2-chome,
Assignee Address Line Two:: Shinjuku-ku
City:: Tokyo
Country:: Japan

2001-75534